

# IRF8788PbF

HEXFET® Power MOSFET

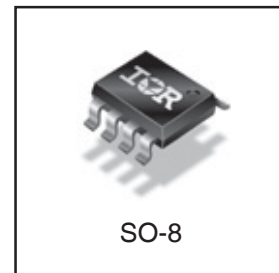
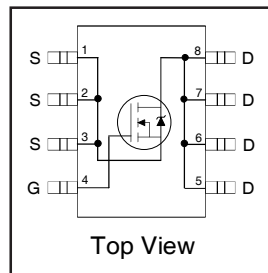
## Applications

- Synchronous MOSFET for Notebook Processor Power
- Synchronous Rectifier MOSFET for Isolated DC-DC Converters

| $V_{DS}$ | $R_{DS(on)}$ max            | Qg   |
|----------|-----------------------------|------|
| 30V      | $2.8m\Omega @ V_{GS} = 10V$ | 44nC |

## Benefits

- Very Low Gate Charge
- Very Low  $R_{DS(on)}$  at 4.5V  $V_{GS}$
- Ultra-Low Gate Impedance
- Fully Characterized Avalanche Voltage and Current
- 20V  $V_{GS}$  Max. Gate Rating
- 100% tested for Rg
- Lead-Free



## Description

The IRF8788PbF incorporates the latest HEXFET Power MOSFET Silicon Technology into the industry standard SO-8 package. The IRF8788PbF has been optimized for parameters that are critical in synchronous buck operation including  $R_{ds(on)}$  and gate charge to reduce both conduction and switching losses. The reduced total losses make this product ideal for high efficiency DC-DC converters that power the latest generation of processors for notebook and Netcom applications.

## Absolute Maximum Ratings

|                          | Parameter                                | Max.         | Units         |
|--------------------------|------------------------------------------|--------------|---------------|
| $V_{DS}$                 | Drain-to-Source Voltage                  | 30           | V             |
| $V_{GS}$                 | Gate-to-Source Voltage                   | $\pm 20$     |               |
| $I_D @ T_A = 25^\circ C$ | Continuous Drain Current, $V_{GS} @ 10V$ | 24           | A             |
| $I_D @ T_A = 70^\circ C$ | Continuous Drain Current, $V_{GS} @ 10V$ | 19           |               |
| $I_{DM}$                 | Pulsed Drain Current ①                   | 190          |               |
| $P_D @ T_A = 25^\circ C$ | Power Dissipation                        | 2.5          | W             |
| $P_D @ T_A = 70^\circ C$ | Power Dissipation                        | 1.6          |               |
|                          | Linear Derating Factor                   | 0.02         | W/ $^\circ C$ |
| $T_J$                    | Operating Junction and                   | -55 to + 150 | $^\circ C$    |
| $T_{STG}$                | Storage Temperature Range                |              |               |

## Thermal Resistance

|                 | Parameter                | Typ. | Max. | Units        |
|-----------------|--------------------------|------|------|--------------|
| $R_{\theta JL}$ | Junction-to-Drain Lead ⑤ | —    | 20   | $^\circ C/W$ |
| $R_{\theta JA}$ | Junction-to-Ambient ④ ⑤  | —    | 50   |              |

Notes ① through ⑤ are on page 9

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# IRF8788PbF

International  
IR Rectifier

Static @  $T_J = 25^\circ\text{C}$  (unless otherwise specified)

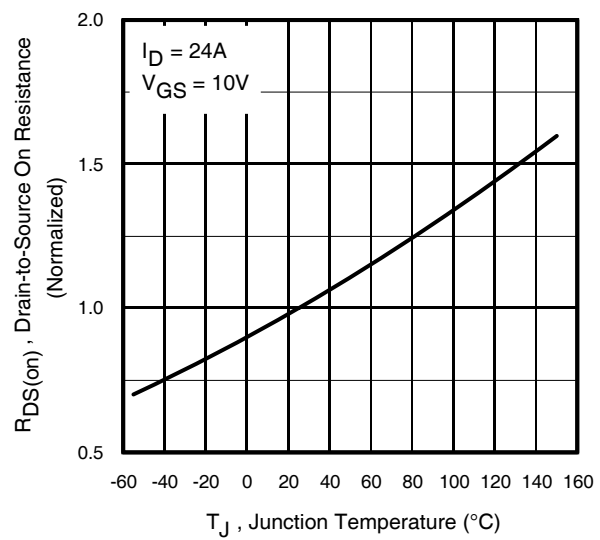
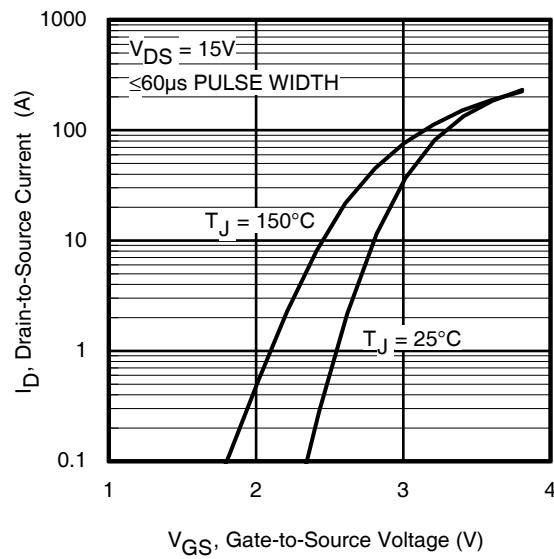
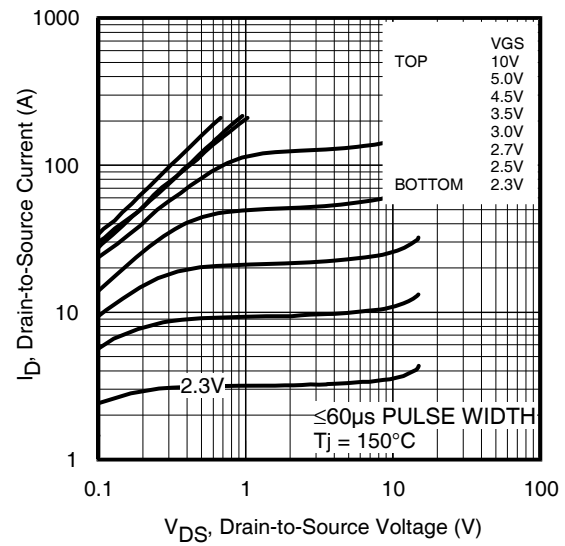
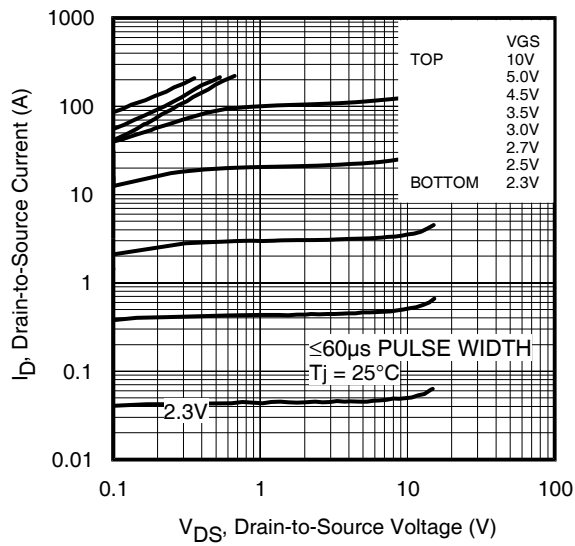
|                              | Parameter                                  | Min. | Typ.  | Max. | Units                | Conditions                                                                              |
|------------------------------|--------------------------------------------|------|-------|------|----------------------|-----------------------------------------------------------------------------------------|
| $BV_{DSS}$                   | Drain-to-Source Breakdown Voltage          | 30   | —     | —    | V                    | $V_{GS} = 0V, I_D = 250\mu A$                                                           |
| $\Delta BV_{DSS}/\Delta T_J$ | Breakdown Voltage Temp. Coefficient        | —    | 0.024 | —    | V/ $^\circ\text{C}$  | Reference to $25^\circ\text{C}, I_D = 1mA$                                              |
| $R_{DS(on)}$                 | Static Drain-to-Source On-Resistance       | —    | 2.3   | 2.8  | m $\Omega$           | $V_{GS} = 10V, I_D = 24A$ ③                                                             |
|                              |                                            | —    | 3.04  | 3.8  |                      | $V_{GS} = 4.5V, I_D = 19A$ ③                                                            |
| $V_{GS(th)}$                 | Gate Threshold Voltage                     | 1.35 | 1.80  | 2.35 | V                    | $V_{DS} = V_{GS}, I_D = 100\mu A$                                                       |
| $\Delta V_{GS(th)}$          | Gate Threshold Voltage Coefficient         | —    | -6.59 | —    | mV/ $^\circ\text{C}$ |                                                                                         |
| $I_{DSS}$                    | Drain-to-Source Leakage Current            | —    | —     | 1.0  | $\mu A$              | $V_{DS} = 24V, V_{GS} = 0V$                                                             |
|                              |                                            | —    | —     | 150  |                      | $V_{DS} = 24V, V_{GS} = 0V, T_J = 125^\circ\text{C}$                                    |
| $I_{GSS}$                    | Gate-to-Source Forward Leakage             | —    | —     | 100  | nA                   | $V_{GS} = 20V$                                                                          |
|                              | Gate-to-Source Reverse Leakage             | —    | —     | -100 |                      | $V_{GS} = -20V$                                                                         |
| $g_{fs}$                     | Forward Transconductance                   | 95   | —     | —    | S                    | $V_{DS} = 15V, I_D = 19A$                                                               |
| $Q_g$                        | Total Gate Charge                          | —    | 44    | 66   | nC                   | $V_{DS} = 15V$<br>$V_{GS} = 4.5V$<br>$I_D = 19A$<br>See Figs. 17a & 17b                 |
| $Q_{gs1}$                    | Pre-V <sub>th</sub> Gate-to-Source Charge  | —    | 12    | —    |                      |                                                                                         |
| $Q_{gs2}$                    | Post-V <sub>th</sub> Gate-to-Source Charge | —    | 4.7   | —    |                      |                                                                                         |
| $Q_{gd}$                     | Gate-to-Drain Charge                       | —    | 14    | —    |                      |                                                                                         |
| $Q_{godr}$                   | Gate Charge Overdrive                      | —    | 13.3  | —    |                      |                                                                                         |
| $Q_{sw}$                     | Switch Charge ( $Q_{gs2} + Q_{gd}$ )       | —    | 18.7  | —    |                      |                                                                                         |
| $Q_{oss}$                    | Output Charge                              | —    | 22    | —    | nC                   | $V_{DS} = 16V, V_{GS} = 0V$                                                             |
| $R_g$                        | Gate Resistance                            | —    | 0.54  | 1.09 | $\Omega$             |                                                                                         |
| $t_{d(on)}$                  | Turn-On Delay Time                         | —    | 23    | —    | ns                   | $V_{DD} = 15V, V_{GS} = 4.5V$<br>$I_D = 19A$<br>$R_G = 1.8\Omega$<br>See Fig. 15a & 15b |
| $t_r$                        | Rise Time                                  | —    | 24    | —    |                      |                                                                                         |
| $t_{d(off)}$                 | Turn-Off Delay Time                        | —    | 23    | —    |                      |                                                                                         |
| $t_f$                        | Fall Time                                  | —    | 11    | —    |                      |                                                                                         |
| $C_{iss}$                    | Input Capacitance                          | —    | 5720  | —    | pF                   | $V_{GS} = 0V$<br>$V_{DS} = 15V$<br>$f = 1.0MHz$                                         |
| $C_{oss}$                    | Output Capacitance                         | —    | 980   | —    |                      |                                                                                         |
| $C_{rss}$                    | Reverse Transfer Capacitance               | —    | 450   | —    |                      |                                                                                         |

## Avalanche Characteristics

|          | Parameter                       | Typ. | Max. | Units |
|----------|---------------------------------|------|------|-------|
| $E_{AS}$ | Single Pulse Avalanche Energy ② | —    | 230  | mJ    |
| $I_{AR}$ | Avalanche Current ①             | —    | 19   | A     |

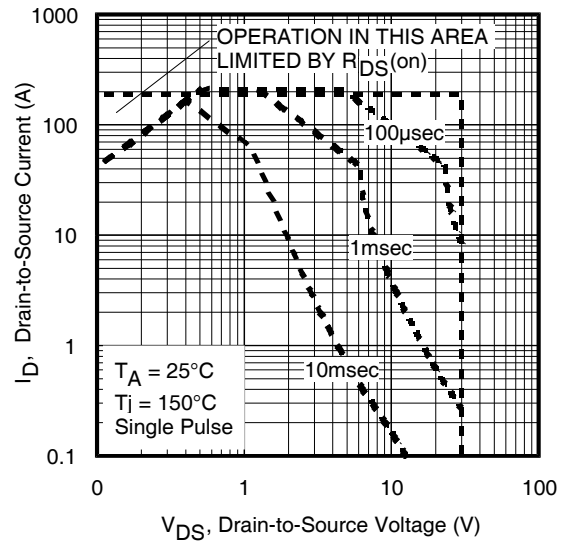
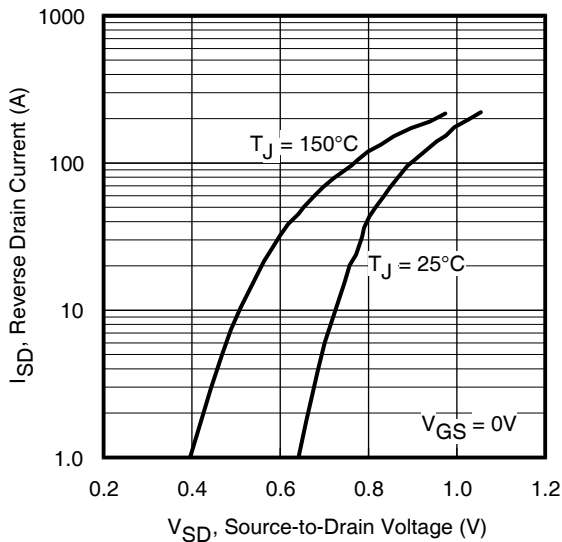
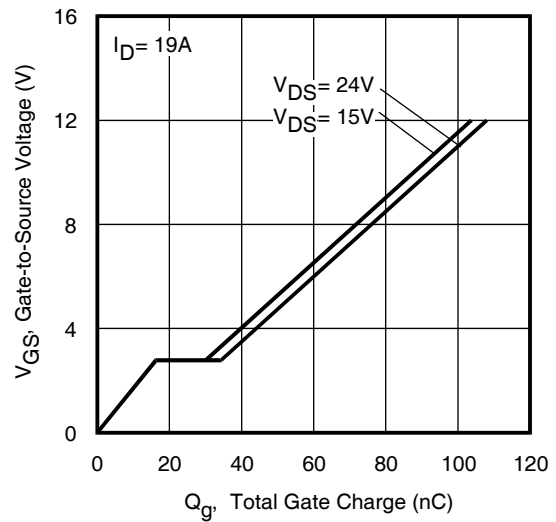
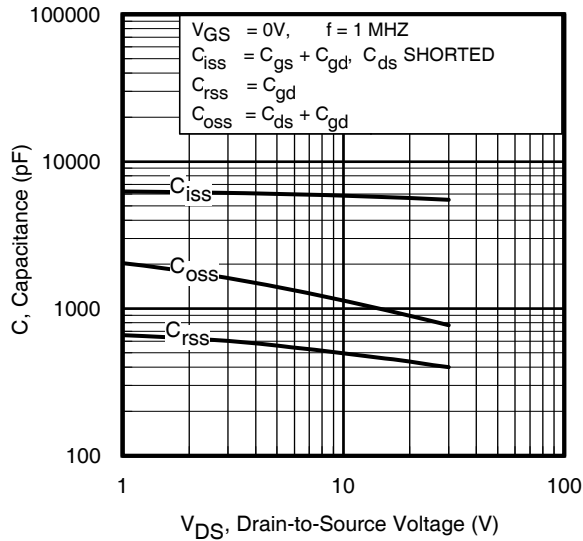
## Diode Characteristics

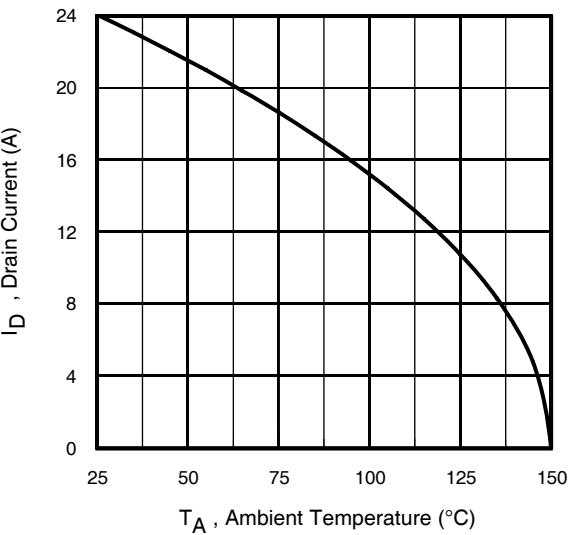
|          | Parameter                                 | Min.                                                                 | Typ. | Max. | Units | Conditions                                                              |
|----------|-------------------------------------------|----------------------------------------------------------------------|------|------|-------|-------------------------------------------------------------------------|
| $I_S$    | Continuous Source Current<br>(Body Diode) | —                                                                    | —    | 3.1  | A     | MOSFET symbol<br>showing the<br>integral reverse<br>p-n junction diode. |
| $I_{SM}$ | Pulsed Source Current<br>(Body Diode) ①   | —                                                                    | —    | 190  | A     |                                                                         |
| $V_{SD}$ | Diode Forward Voltage                     | —                                                                    | —    | 1.0  | V     | $T_J = 25^\circ\text{C}, I_S = 19A, V_{GS} = 0V$ ③                      |
|          |                                           | —                                                                    | —    | 0.75 | V     | $T_J = 25^\circ\text{C}, I_S = 2.2A, V_{GS} = 0V$ ③                     |
| $t_{rr}$ | Reverse Recovery Time                     | —                                                                    | 24   | 36   | ns    | $T_J = 25^\circ\text{C}, I_F = 19A, V_{DD} = 15V$                       |
| $Q_{rr}$ | Reverse Recovery Charge                   | —                                                                    | 33   | 50   | nC    | $di/dt = 230A/\mu s$ ③                                                  |
| $t_{on}$ | Forward Turn-On Time                      | Intrinsic turn-on time is negligible (turn-on is dominated by LS+LD) |      |      |       |                                                                         |



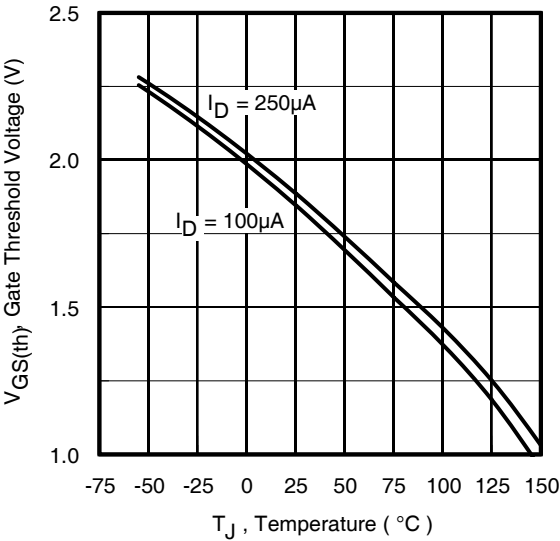
# IRF8788PbF

International  
**IR** Rectifier

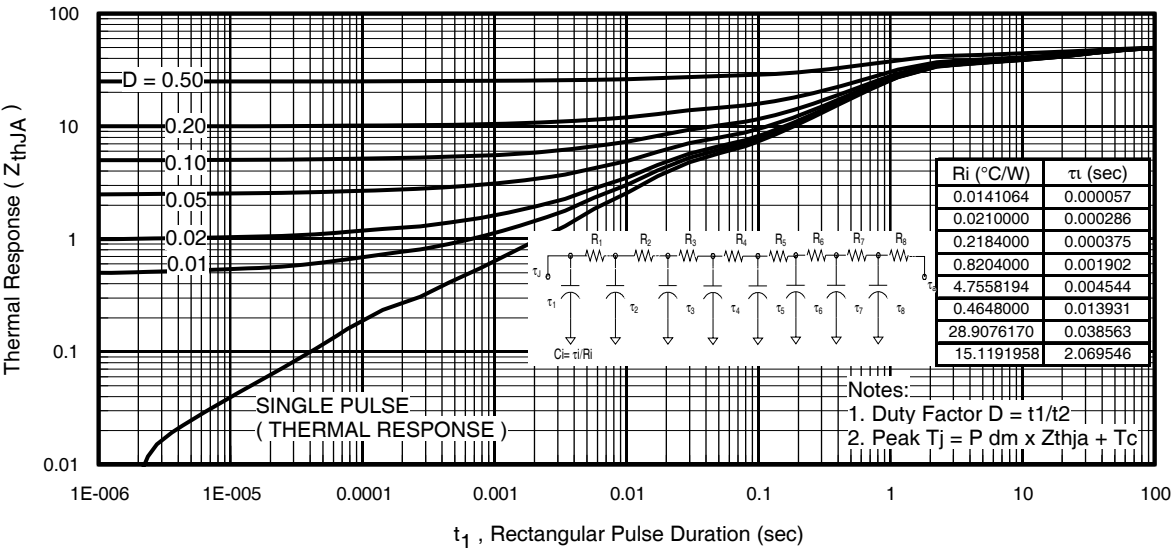




**Fig 9.** Maximum Drain Current vs. Ambient Temperature



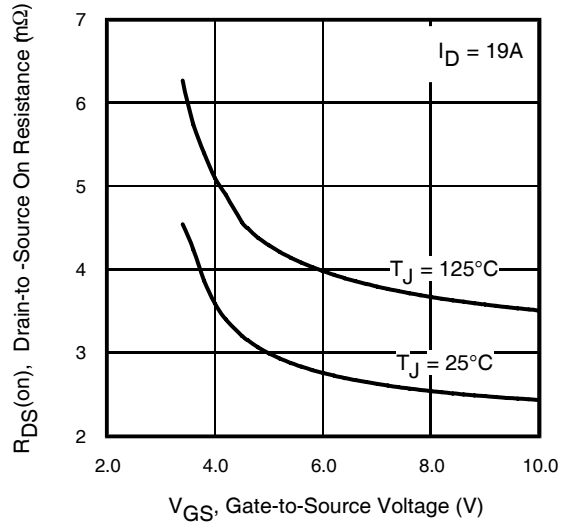
**Fig 10.** Threshold Voltage vs. Temperature



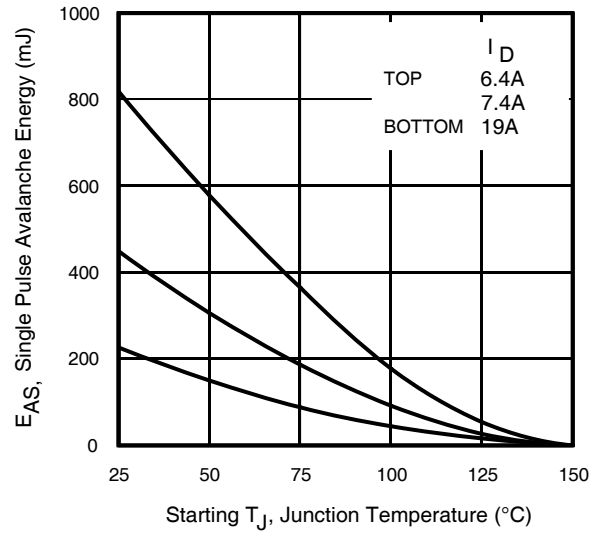
**Fig 11.** Maximum Effective Transient Thermal Impedance, Junction-to-Ambient

# IRF8788PbF

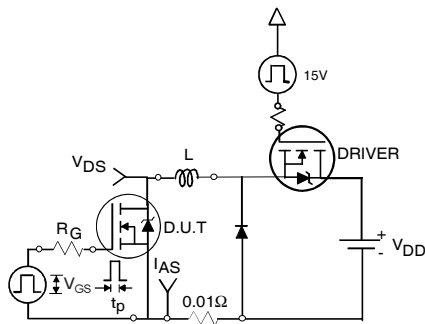
International  
**IR** Rectifier



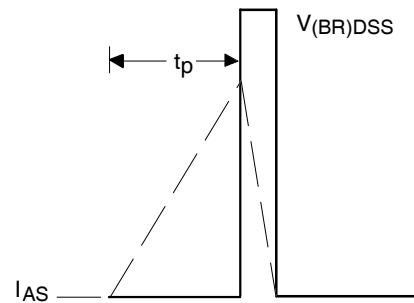
**Fig 12.** On-Resistance vs. Gate Voltage



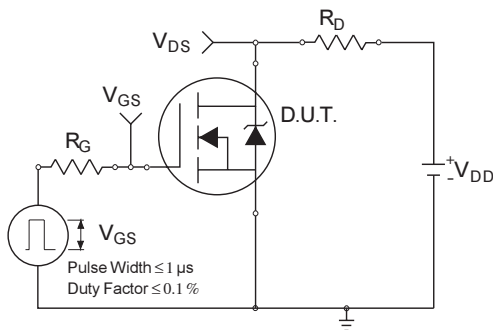
**Fig 13.** Maximum Avalanche Energy vs. Drain Current



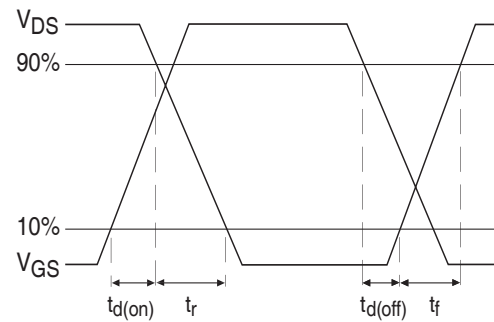
**Fig 14a.** Unclamped Inductive Test Circuit



**Fig 14b.** Unclamped Inductive Waveforms

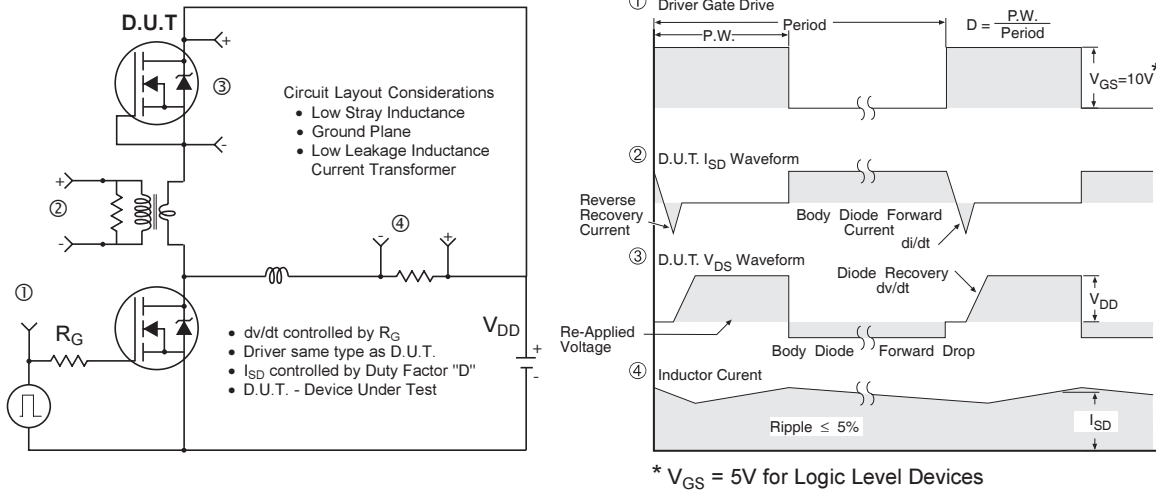


**Fig 15a.** Switching Time Test Circuit

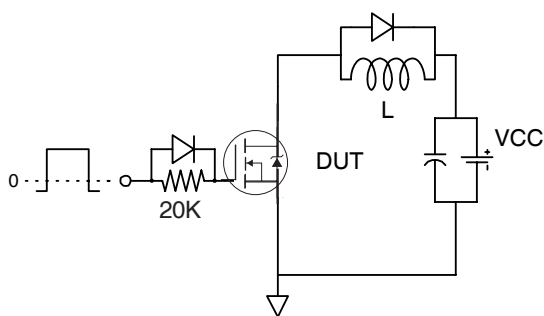


**Fig 15b.** Switching Time Waveforms

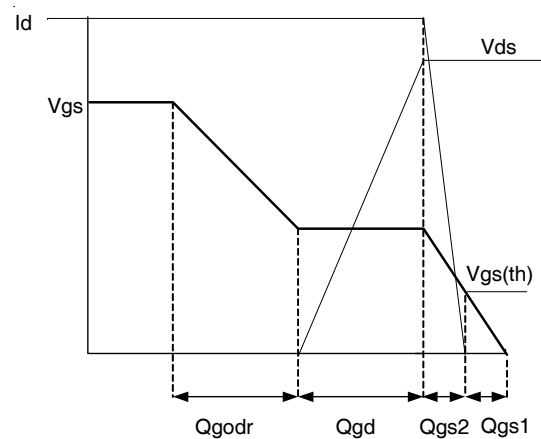
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**Fig 16. Peak Diode Recovery  $dv/dt$  Test Circuit for N-Channel HEXFET® Power MOSFETs**



**Fig 17a. Gate Charge Test Circuit**



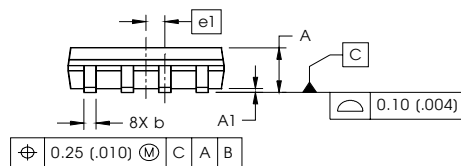
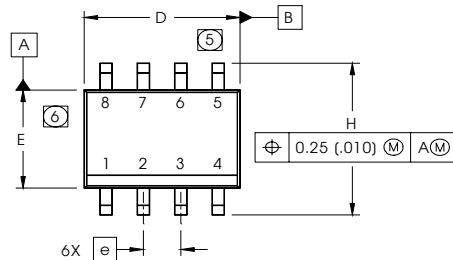
**Fig 17b. Gate Charge Waveform**

# IRF8788PbF

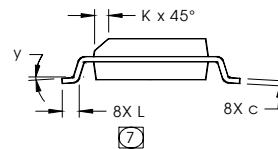
## SO-8 Package Outline

Dimensions are shown in millimeters (inches)

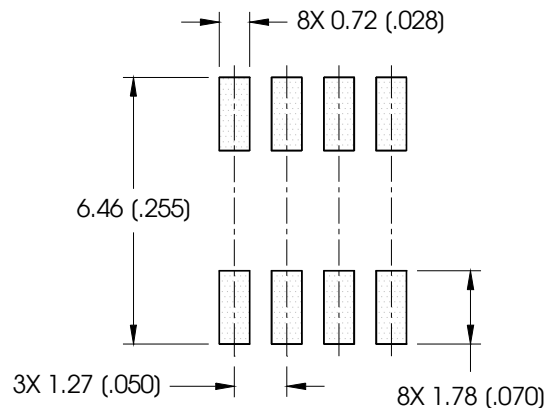
International  
**IR** Rectifier



| DIM | INCHES     |       | MILLIMETERS |      |
|-----|------------|-------|-------------|------|
|     | MIN        | MAX   | MIN         | MAX  |
| A   | .0532      | .0688 | 1.35        | 1.75 |
| A1  | .0040      | .0098 | 0.10        | 0.25 |
| b   | .013       | .020  | 0.33        | 0.51 |
| c   | .0075      | .0098 | 0.19        | 0.25 |
| D   | .189       | .1968 | 4.80        | 5.00 |
| E   | .1497      | .1574 | 3.80        | 4.00 |
| e   | .050 BASIC |       | 1.27 BASIC  |      |
| e1  | .025 BASIC |       | 0.635 BASIC |      |
| H   | .2284      | .2440 | 5.80        | 6.20 |
| K   | .0099      | .0196 | 0.25        | 0.50 |
| L   | .016       | .050  | 0.40        | 1.27 |
| y   | 0°         | 8°    | 0°          | 8°   |



### FOOTPRINT

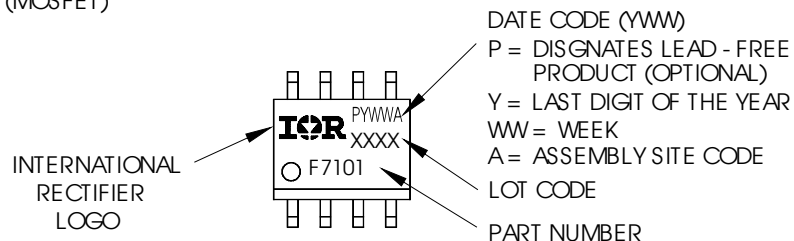


#### NOTES:

1. DIMENSIONING & TOLERANCING PER ASME Y14.5M-1994.
2. CONTROLLING DIMENSION: MILLIMETER
3. DIMENSIONS ARE SHOWN IN MILLIMETERS (INCHES).
4. OUTLINE CONFORMS TO JEDEC OUTLINE MS-012AA.
- ⑤ DIMENSION DOES NOT INCLUDE MOLD PROTRUSIONS. MOLD PROTRUSIONS NOT TO EXCEED 0.15 (.006).
- ⑥ DIMENSION DOES NOT INCLUDE MOLD PROTRUSIONS. MOLD PROTRUSIONS NOT TO EXCEED 0.25 (.010).
- ⑦ DIMENSION IS THE LENGTH OF LEAD FOR SOLDERING TO A SUBSTRATE.

## SO-8 Part Marking Information

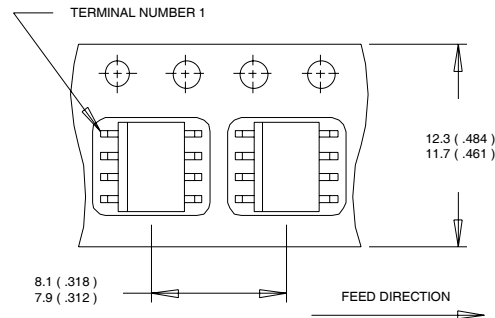
EXAMPLE: THIS IS AN IRF7101 (MOSFET)



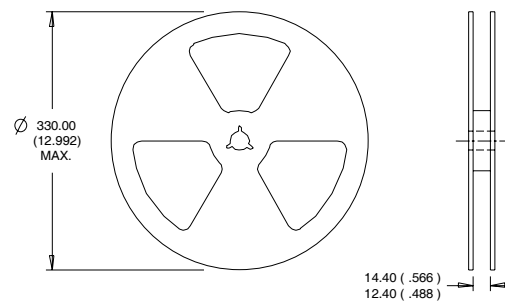
Note: For the most current drawing please refer to IR website at <http://www.irf.com/package/>

## SO-8 Tape and Reel

Dimensions are shown in millimeters (inches)



NOTES:  
1. CONTROLLING DIMENSION : MILLIMETER.  
2. ALL DIMENSIONS ARE SHOWN IN MILLIMETERS(INCHES).  
3. OUTLINE CONFORMS TO EIA-481 & EIA-541.



NOTES :  
1. CONTROLLING DIMENSION : MILLIMETER.  
2. OUTLINE CONFORMS TO EIA-481 & EIA-541.

### Notes:

- ① Repetitive rating; pulse width limited by max. junction temperature.
- ② Starting  $T_J = 25^\circ\text{C}$ ,  $L = 1.25\text{mH}$ ,  $R_G = 25\Omega$ ,  $I_{AS} = 19\text{A}$ .
- ③ Pulse width  $\leq 400\mu\text{s}$ ; duty cycle  $\leq 2\%$ .
- ④ When mounted on 1 inch square copper board.
- ⑤  $R_\theta$  is measured at  $T_J$  of approximately  $90^\circ\text{C}$ .

Note: For the most current drawing please refer to IR website at <http://www.irf.com/package/>

Data and specifications subject to change without notice.  
This product has been designed and qualified for the Consumer market.  
Qualification Standards can be found on IR's Web site.

# AMEYA360

Components Supply Platform

Authorized Distribution Brand :



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